

# LM2793

*LM2793 Low Noise White LED Constant Current Supply with Dual Function  
Brightness Control*



Literature Number: SNVS228

## LM2793

# Low Noise White LED Constant Current Supply with Dual Function Brightness Control

### General Description

The LM2793 is a highly efficient, semi-regulated 1.5x CMOS charge pump that provides dual constant current outputs. The LM2793 has an input voltage range of 2.7V to 5.5V.

To control LED brightness, the amount of current driven to the current-mode outputs can be adjusted with an analog voltage and/or a pulse-width-modulated (PWM) square wave.

Pre-regulation of the charge pump minimizes conducted noise on the input. Combined with a fixed switching frequency of 500kHz, the LM2793 is a low-noise solution.

The LM2793 is available in a 10-pin Leadless Lead-frame package: LLP-10.

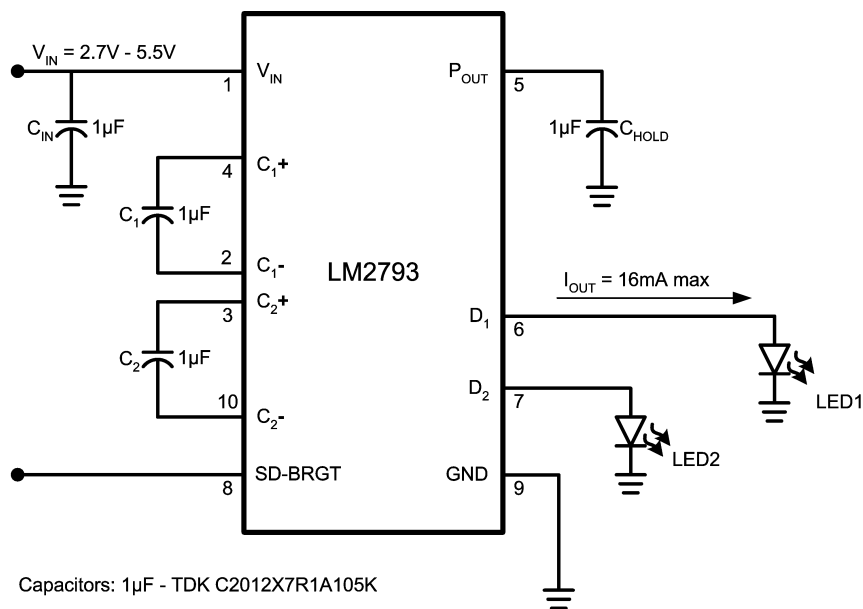
### Features

- Two Regulated Current Outputs, up to 16mA Each, Matched to Within  $\pm 0.3\%$  (typ.)
- High Efficiency, 1.5x Regulated Charge Pump
- Input Voltage Range: 2.7V to 5.5V
- Soft Start Limits Inrush Current
- Analog Voltage Brightness Control
- PWM Brightness Control
- Very Small Solution Size - NO INDUCTOR
- 500kHz Switching Frequency
- 3 $\mu$ A (typ.) Shutdown Current
- LLP-10 Package: 3.0mm X 3.0mm X 0.8mm

### Applications

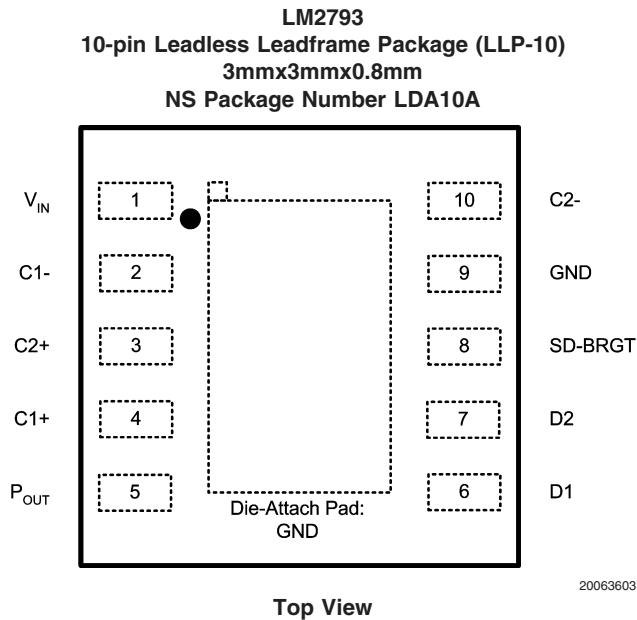
- White LED Display Backlights
- White LED Keypad Backlights
- 1-Cell Lilon Battery-Operated Equipment Including PDAs, Hand-held PCs, Cellular Phones
- Flat Panel Displays

### Typical Application Circuit



20063602

Connection Diagram



Ordering Information

Order Number	Package Description	Package Marking	Supplied as Tape and Reel (Units)
LM2793LD	LLP-10	LM2793	1000
LM2793LDX	LLP-10	LM2793	4500

Pin Description

Pin	Name	Description
1	V <sub>IN</sub>	Power supply voltage connection
2	C1-	Flying capacitor C1 connection
3	C2+	Flying capacitor C2 connection
4	C1+	Flying capacitor C1 connection
5	P <sub>OUT</sub>	Charge pump output
6	D1	Current source output / LED connection
7	D2	Current source output / LED connection
8	SD-BRGT	Dual function Shutdown - Brightness. Grounding pin shuts down part. Voltage between 0.75V and 2.75V (typ.) linearly adjusts current outputs. Output current equals 16mA at voltages above 2.75V.
9	GND	Power supply ground connection
10	C2-	Flying capacitor C2 connection

**Absolute Maximum Ratings** (Notes 1,

2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

$V_{IN}$	-0.3V to 6.0V
$V_{SD-BRGT}$	-0.3V to ( $V_{IN} + 0.3V$ ) w/ 6.0V max

Continuous Power Dissipation (Note 4)

Internally Limited

Junction Temperature ( $T_{J-MAX-ABS}$ ) 150°C

Storage Temperature Range -65°C to 150°C

Lead Temp. (Soldering, 5 sec.) 260°C

ESD Rating (Note 5)

Human Body Model 2kV

Machine Model 200V

**Operating Ratings** (Notes 2, 8)

Input Voltage $V_{IN}$	2.7V to 5.5V
$V_{SD-BRGT}$	0V to $V_{IN}$
Brightness Adjustment Control	
Range of $V_{SD-BRGT}$	0.75V to 2.75V
Junction Temperature Range ( $T_J$ )	-30°C to +100°C
Ambient Temperature Range ( $T_A$ )	-30°C to +85 °C (Note 6)

**Thermal Information**

Junction-to-Ambient Thermal Resistance,	
LLP-10 Package ( $\theta_{JA}$ ) (Note 7)	55°C/W

**Electrical Characteristics** (Notes 2, 8)

Limits in standard typeface are for  $T_J = 25^\circ\text{C}$ , and limits in **boldface** type apply over the full operating junction temperature range. Unless otherwise specified:  $C_1=C_2=C_{IN}=C_{HOLD}=1\mu\text{F}$ ;  $V_{IN}=3.6\text{V}$ ;  $V_{SD-BRGT}=3.0\text{V}$ ;  $V_{DX}=3.6\text{V}$

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{DX}$	Output Current Regulation	$3.3V \leq V_{IN} \leq 5.5V$ $V_{DX} = 3.9V$	14.7 <b>13.7</b>	15.9	17.2 <b>17.3</b>	mA
		$3.0V \leq V_{IN} \leq 5.5V$ $V_{DX} = 3.8V$	14.7 <b>13.7</b>	15.9	17.2 <b>17.3</b>	
		$2.7V \leq V_{IN} \leq 5.5V$ $V_{DX} = 3.4V$	14.7 <b>13.7</b>	15.9	17.2 <b>17.3</b>	
		$2.5V \leq V_{DX} \leq 3.9V$ (Note 9)	14.7 <b>13.7</b>	15.9	17.2 <b>17.3</b>	
		$V_{SD-BRGT} = 2.0V$		10		
		$V_{SD-BRGT} = 0.75V$		0.1		
$I_{D-MATCH}$	$I_{D1}$ -to- $I_{D2}$ Current Matching			0.3	<b>3.0</b>	%
$R_{OUT}$	Charge Pump Output Resistance	$V_{IN} = 2.7V$		3.5		$\Omega$
$V_{HR-min}$	Minimum Current Source Voltage Headroom ( $V_{P-OUT} - V_{IDX}$ ) (Note 10)	$I_{DX} = 16\text{mA}$		400		mV
$I_Q$	Quiescent Supply Current	$I_{DX}, I_{P-OUT} = 0$		1.2	<b>2.2</b>	mA
$I_{SD}$	Shutdown Supply Current	$2.7V \leq V_{IN} \leq 5.5V$ $V_{SD-BRGT} = 0V$		3	<b>5</b>	$\mu\text{A}$
ON/OFF	SD-BRGT Pin Thresholds for Active and Shutdown Modes	Active $V_{IN} = 3.0V$	<b>0.70</b>			V
		Shutdown $V_{IN} = 3.0V$			<b>0.25</b>	
$I_{LEAK-SD}$	SD-BRGT Pin Leakage Current			17		$\mu\text{A}$
$f_{SW}$	Switching Frequency	$2.7V \leq V_{IN} \leq 5.5V$	<b>325</b>	500	<b>675</b>	kHz
$t_{START}$	Startup Time	$I_{DX} = 90\%$ steady state		30		$\mu\text{s}$

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the component may occur. Operating Ratings are conditions under which operation of the device is guaranteed. Operating Ratings do not imply guaranteed performance limits. For guaranteed performance limits and associated test conditions, see the Electrical Characteristics tables.

**Note 2:** All voltages are with respect to the potential at the GND pin.

**Note 3:** Voltage on the SD-BRGT pin should not exceed 6V.

**Note 4:** Thermal shutdown circuitry protects the device from permanent damage.  $D_1$  and  $D_2$  may be shorted to GND without damage.

## Electrical Characteristics (Notes 2, 8) (Continued)

**Note 5:** The human-body model is a 100 pF capacitor discharged through a 1.5 k resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.

**Note 6:** Maximum ambient temperature ( $T_{A-MAX}$ ) is dependent on the maximum operating junction temperature ( $T_{J-MAX-OP} = 100^{\circ}\text{C}$ ), the maximum power dissipation of the device in the application ( $P_{D-MAX}$ ), and the junction-to-ambient thermal resistance of the part/package in the application ( $\theta_{JA}$ ), as given by the following equation:  $T_{A-MAX} = T_{J-MAX-OP} - (\theta_{JA} \times P_{D-MAX})$ . The ambient temperature operating rating is provided merely for convenience. This part may be operated outside the listed  $T_A$  rating, so long as the junction temperature of the device does not exceed the maximum operating rating of  $100^{\circ}\text{C}$ .

**Note 7:** Junction-to-ambient thermal resistance is highly application and board-layout dependent. In applications where high maximum power dissipation exists, special care must be paid to thermal dissipation issues. For more information on these topics, please refer to the **Power Dissipation** section of this datasheet.

**Note 8:** All room temperature limits are 100% tested or guaranteed through statistical analysis. All limits at temperature extremes are guaranteed by correlation using standard Statistical Quality Control methods (SQC). All limits are used to calculate Average Outgoing Quality Level (AOQL). Typical numbers are not guaranteed, but do represent the most likely norm.

**Note 9:** Maximum LED voltage ( $V_{DX}$ ) is highly dependent on the application's minimum input voltage and the amount of current flowing through the LEDs. Maximum LED voltage for a given application can be approximated with the following equations:

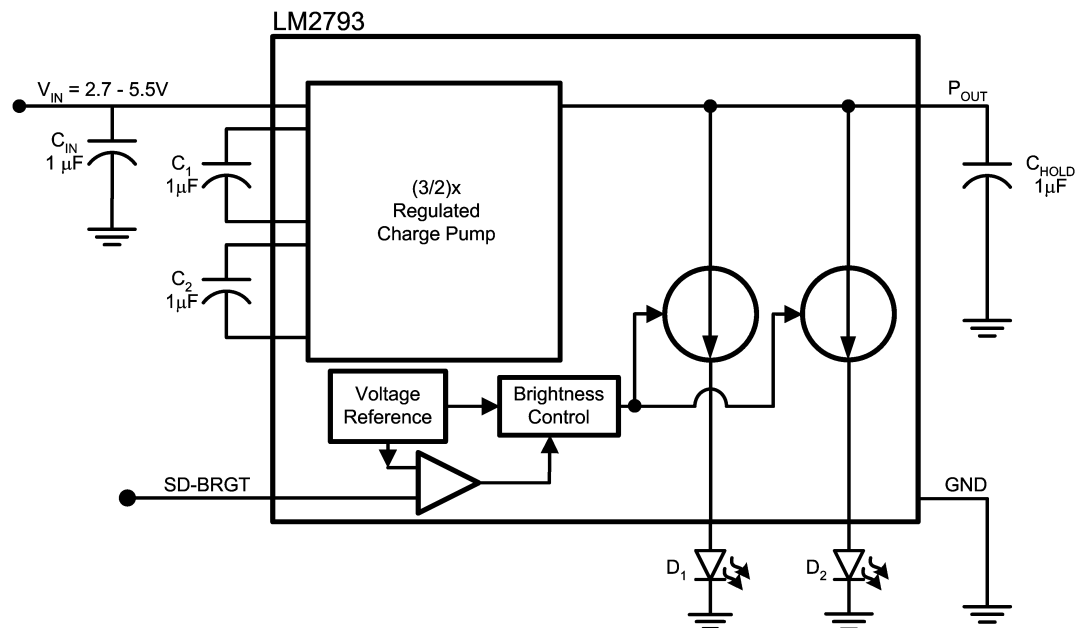
$$V_{IN-MIN} < 3.0V: V_{DX-MAX} = (1.5 \times V_{IN-MIN}) - (I_{DX} \times 25 \text{ mV/mA}) - (3.5\Omega \times 2 \times I_{DX})$$

$$V_{IN-MIN} \geq 3.0V: V_{DX-MAX} = 4.3V - (I_{DX} \times 25 \text{ mV/mA})$$

The equations above assume LEDs are connected to outputs  $D_1$  and  $D_2$ , and no current drawn from the charge pump output ( $P_{OUT}$ ). For a more precise and thorough analysis of maximum LED voltage, please refer to text sections of the datasheet (to appear in future datasheet revisions - in the interim, please contact National Semiconductor for more information).

**Note 10:** Current sources are connected internally between  $P_{OUT}$  and  $I_{DX}$ . The voltage across each current source,  $[V(P_{OUT}) - V(I_{DX})]$ , is referred to as headroom voltage. For current sources to regulate properly, a minimum headroom voltage must be present across them. Minimum required headroom voltage is proportional to the current flowing through the current source, as dictated by this equation:  $V_{HR-min} = 400\text{mV} \times (I_{DX} / 16\text{mA})$ .

## Block Diagram

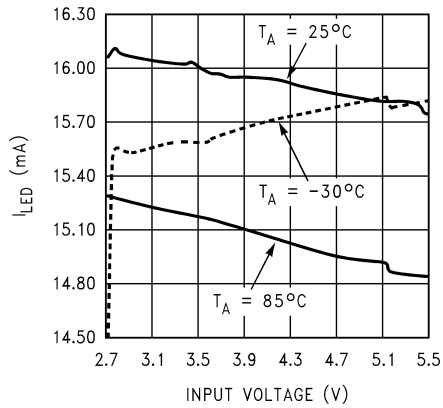


20063601

## Typical Performance Characteristics

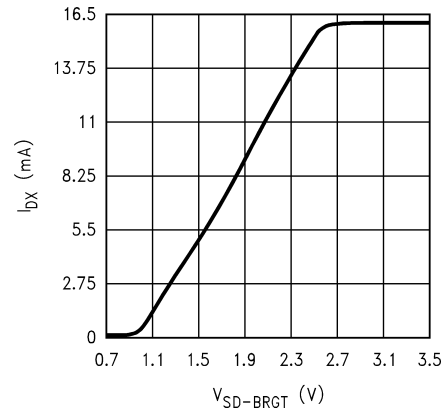
Unless otherwise specified:  $T_A = 25^\circ\text{C}$ , 2 LEDs,  $V_{DX} = 3.6\text{V}$ ,  $V_{IN} = 3.6$ ,  $V_{SD-BRGT} = 3.0$ ,  $C_1 = C_2 = C_{IN} = C_{HOLD} = 1\mu\text{F}$ . Capacitors are low-ESR multi-layer ceramic capacitors (MLCC's).

### LED Current vs. Input Voltage



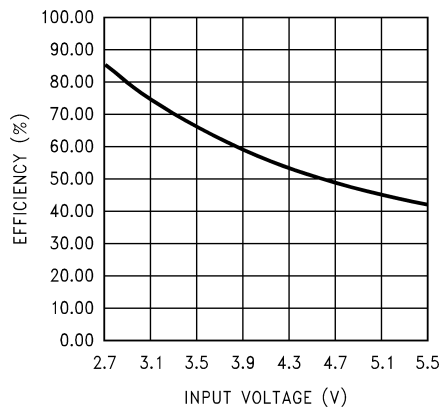
20063606

### LED Current vs. SD-BRGT Voltage



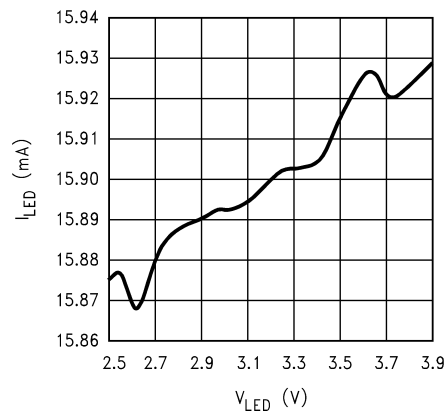
20063607

### Efficiency vs. Input Voltage



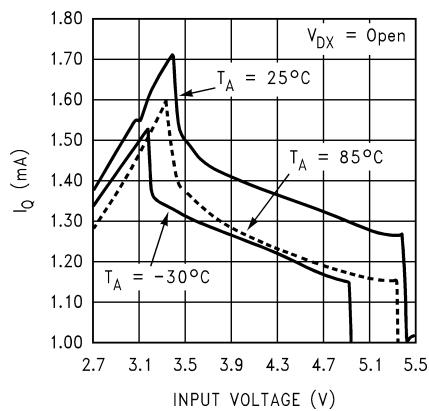
20063612

### LED Current vs. LED Voltage



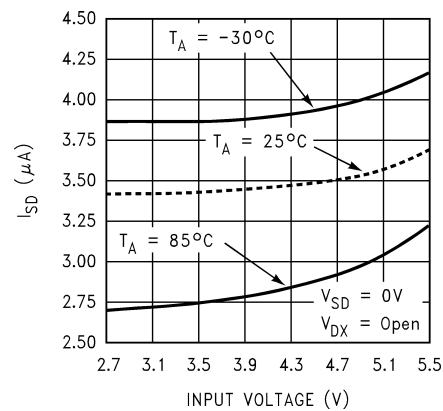
20063608

### Quiescent Current vs. Input Voltage



20063609

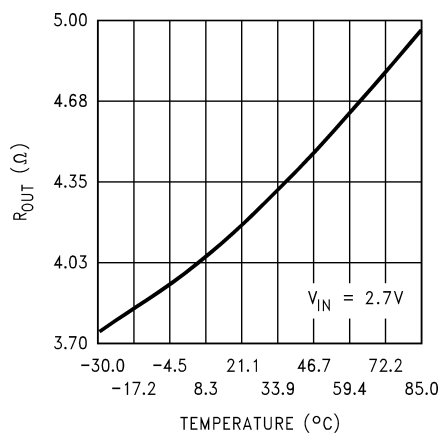
### Shutdown Supply Current vs. Input Voltage



20063610

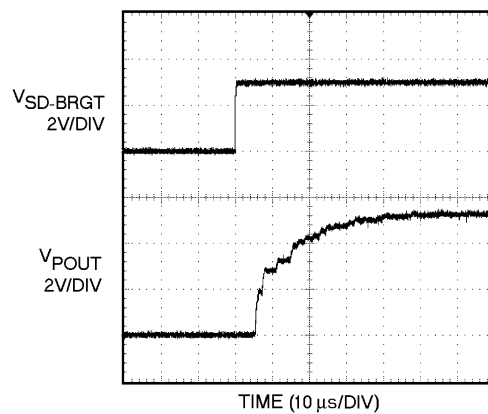
**Typical Performance Characteristics** Unless otherwise specified:  $T_A = 25^\circ\text{C}$ , 2 LEDs,  $V_{DX} = 3.6\text{V}$ ,  $V_{IN} = 3.6$ ,  $V_{SD-BRGT} = 3.0$ ,  $C_1 = C_2 = C_{IN} = C_{HOLD} = 1\mu\text{F}$ . Capacitors are low-ESR multi-layer ceramic capacitors (MLCC's). (Continued)

**Output Resistance vs. Temperature**



20063611

**Startup Response**



20063614

## Application Information

### CIRCUIT DESCRIPTION

The LM2793 is a 1.5x CMOS charge pump that provides two matched constant current outputs for driving up to 16mA through high forward voltage drop White LEDs from Li-Ion battery sources. The device has two regulated current sources connected to the output of the device's 1.5x loosely regulated charge pump ( $P_{OUT}$ ). The device's loosely-regulated charge pump has both open loop and closed loop modes of operation. When the device is in open loop, the voltage at  $P_{OUT}$  is 1.5 times the voltage at the input. When the device is in closed loop, the voltage at  $P_{OUT}$  is loosely regulated to 4.9V (typ.). To set the LED drive current, the device uses the voltage applied to the dual function shutdown-brightness pin (SD-BRGT) to set a reference current. This reference current is then multiplied and mirrored to each current output. The LED brightness can be controlled by both analog and/or digital methods. The digital technique uses a PWM (Pulse Width Modulation) signal applied to the SD-BRGT pin. The analog technique applies an analog voltage in the range of 0.7V to 2.75V to the SD-BRGT pin to vary the LED current (see Shutdown and Brightness Control).

### SOFT START

LM2793 includes a soft start function to reduce the inrush currents and high peak current during power up of the device. Soft start is implemented internally by ramping the reference voltage more slowly than the applied voltage. During soft start, the switch resistances limit the inrush current used to charge the flying and hold capacitors.

### SHUTDOWN AND BRIGHTNESS CONTROL

The LM2793 has an active-low dual function shutdown-brightness control pin, SD-BRGT. A voltage higher than 0.65V (typ.) on SD-BRGT will put the LM2793 in active mode. Applying a voltage below 0.35V (typ.) on the SD-BRGT pin will turn off the device, reducing the quiescent current to 3 $\mu$ A (typ.).

The LM2793 has the ability to adjust LED brightness by applying an analog voltage or a PWM signal to the SD-BRGT pin. For constant brightness or analog brightness control, continue with "Analog brightness control" below. Otherwise go to "Brightness control using PWM".

#### 1. Analog brightness control

The current for the dual LED outputs can be adjusted by varying the voltage on the SD-BRGT pin. The typical range for adjusting LED brightness is between 0.7 and 2.75V. Figure 1 shows how the current changes with respect to the voltage applied to SD-BRGT. If full brightness (16mA) is desired, the voltage on SD-BRGT should be greater than 2.75V (typ.) but not more than  $V_{IN}$ .

#### 2. Brightness control using PWM

Increasing and decreasing the duty cycle of the PWM signal controls the LED brightness. Zero duty cycle will turn off the LEDs and a 50% duty cycle will result in an average  $I_{LED}$  being half of the maximum LED current. The recommended frequency range for the PWM signal is between 100Hz and 1kHz. If the PWM frequency is much less than 100Hz, flicker may be seen in the LEDs. If the frequency is much higher than 1kHz, brightness in the LEDs will not adjust linearly with duty cycle due to the 30 $\mu$ s (typ.) start-up time of the device. The voltage level for the PWM signal should be greater than 2.75V (typ.) but not exceed the voltage on  $V_{IN}$ .

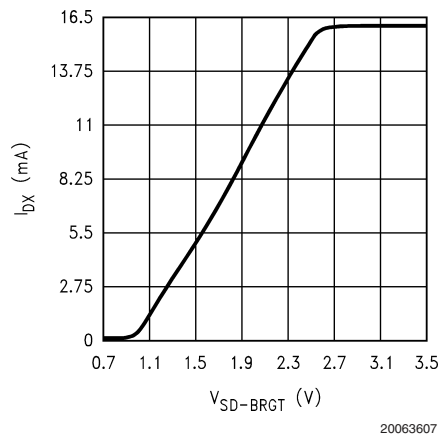


FIGURE 1. LED Current vs.  $V_{SD-BRGT}$   
2 LEDs,  $V_{DX} = 3.6V$ ,  $V_{IN} = 3.6V$

### CAPACITOR SELECTION

The LM2793 requires 4 external capacitors for proper operation. Surface-mount multi-layer ceramic capacitors are recommended. These capacitors are small, inexpensive and have very low equivalent series resistance (ESR,  $\leq 15m\Omega$  typ.). Tantalum capacitors, OS-CON capacitors, and aluminum electrolytic capacitors are generally not recommended for use with the LM2793 due to their high ESR, as compared to ceramic capacitors.

For most applications, ceramic capacitors with X7R or X5R temperature characteristic are preferred for use with the LM2793. These capacitors have tight capacitance tolerance (as good as  $\pm 10\%$ ), hold their value over temperature (X7R:  $\pm 15\%$  over  $-55^\circ C$  to  $125^\circ C$ ; X5R:  $\pm 15\%$  over  $-55^\circ C$  to  $85^\circ C$ ), and typically have little voltage coefficient. Capacitors with Y5V or Z5U temperature characteristic are generally not recommended for use with the LM2793. Capacitors with these temperature characteristics typically have wide capacitance tolerance ( $+80\%$ ,  $-20\%$ ), vary significantly over temperature (Y5V:  $+22\%$ ,  $-82\%$  over  $-30^\circ C$  to  $+85^\circ C$  range; Z5U:  $+22\%$ ,  $-56\%$  over  $+10^\circ C$  to  $+85^\circ C$  range), and have poor voltage coefficients. Under some conditions, a nominal 1 $\mu$ F Y5V or Z5U capacitor could have a capacitance of only 0.1 $\mu$ F. Such detrimental deviation is likely to cause Y5V and Z5U capacitors to fail to meet the minimum capacitance requirements of the LM2793. Table 1 lists suggested capacitor suppliers for the typical application circuit.

TABLE 1. Ceramic Capacitor Manufacturers

Manufacturer	Contact
TDK	<a href="http://www.component.tdk.com">www.component.tdk.com</a>
Murata	<a href="http://www.murata.com">www.murata.com</a>
Taiyo Yuden	<a href="http://www.t-yuden.com">www.t-yuden.com</a>

### LED SELECTION

The LM2793 is designed to drive LEDs with a forward voltage of about 3.0V to 4.0V. The typical and maximum diode forward voltage depends highly on the manufacturer and their technology. Table 2 lists two suggested manufacturers. Forward current matching is assured over the LED process variations due to the constant current output of the LM2793.



## Application Information (Continued)

TABLE 2. White LED Selection

Manufacturer	Contact
Osram	www.osram-os.com
Nichia	www.nichia.com

### PARALLEL DX OUTPUTS FOR INCREASED CURRENT DRIVE

Outputs D<sub>1</sub> and D<sub>2</sub> may be connected together to drive a single LED. In such a configuration, two parallel current sources of equal value drive the single LED. The voltage on SD-BRGT should be chosen so that the current through each of the outputs is programmed to 50% of the total desired LED current. For example, if 30mA is the desired drive current for the single LED, SD-BRGT should be selected so that the current through each of the outputs is 15mA. Connecting the outputs in parallel does not affect internal operation of the LM2793 and has no impact on the Electrical Characteristics and limits previously presented. The available diode output current, maximum diode voltage, and all other specifications provided in the Electrical Characteristics table apply to this parallel output configuration, just as they do to the standard 2-LED application circuit.

### P<sub>OUT</sub>

P<sub>OUT</sub> uses pre-regulation to loosely regulate the output of the LM2793 1.5x charge pump. Pre-regulation uses the voltage present at P<sub>OUT</sub> to limit the gate drive of the 1.5x switched capacitor charge pump. Pre-regulation helps to reduce input current noise and large input current spikes normally associated with switched capacitor charge pumps. At voltages below 3.3V (typ.), the LM2793 acts as an open loop charge pump. When the device is in open loop, the voltage at P<sub>OUT</sub> is 1.5 times the input voltage. At input voltages higher than 3.3V (typ.) P<sub>OUT</sub> is loosely regulated to 4.9V (typ.).

### POWER EFFICIENCY

Figure 2 shows the efficiency of the LM2793.

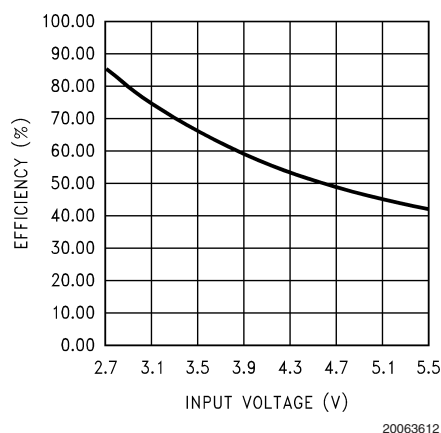


FIGURE 2. Efficiency vs. V<sub>IN</sub>  
2 LEDs, V<sub>LED</sub> = 3.6V, I<sub>LED</sub> = 16mA

Efficiency (E) of the LM2793 is defined here as the ratio of the power consumed by LEDs (P<sub>LED</sub>) to the power drawn from the input source (P<sub>IN</sub>). In the equations below, I<sub>Q</sub> is the quiescent current of the LM2793, I<sub>LED</sub> is the current flowing

through one LED, and V<sub>LED</sub> is the forward voltage at that LED current. In the input power calculation, the 1.5 multiplier reflects the 3/2 switched capacitor gain of the LM2793.

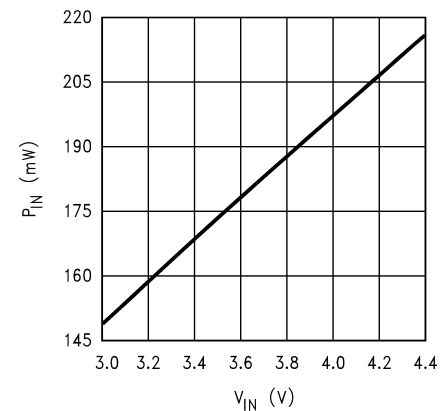
$$P_{LED} = N \times V_{LED} \times I_{LED}$$

$$P_{IN} = V_{IN} \times I_{IN}$$

$$P_{IN} = V_{IN} \times (1.5 \times N \times I_{LED} + I_Q)$$

$$E = (P_{LED} \div P_{IN})$$

It is also worth noting that efficiency as defined here is in part dependent on LED voltage. Variation in LED voltage does not affect power consumed by the circuit and typically does not relate to the brightness of the LED. For an advanced analysis, it is recommended that power consumed by the circuit (V<sub>IN</sub> × I<sub>IN</sub>) be evaluated rather than power efficiency. Power consumption of the LM2793 Typical Application Circuit is shown in Figure 3.



20063613

FIGURE 3. I<sub>LED</sub> current vs. P<sub>IN</sub>  
2 LEDs, 2.5 ≤ V<sub>LED</sub> ≤ 3.9V, I<sub>LED</sub> = 16mA

### THERMAL PROTECTION

When the junction temperature exceeds 150°C, the LM2793 internal thermal protection circuitry disables the part. This feature protects the device from damage due to excessive power dissipation. The device will recover and operate normally when the junction temperature falls below 125°C. It is important to have good thermal conduction with a proper layout to reduce thermal resistance.

### POWER DISSIPATION

When operating within specified operating ratings, the peak power dissipation (P<sub>DISSIPATION</sub>) of the LM2793 occurs at an input voltage of 5.5V. Assuming a typical junction-to-ambient thermal resistance (θ<sub>JA</sub>) for the LLP-10 package of 55°C/W, a LED forward voltage (V<sub>DX</sub>) of 3.6V, and a total load (I<sub>LOAD</sub>) of 32mA for two White LEDs connected to D<sub>1</sub> and D<sub>2</sub>, the power dissipation and junction temperature (T<sub>J</sub>) are calculated below for a part operating at the maximum rated ambient temperature (T<sub>A</sub>) of 85°C. In the equations below, V<sub>IN</sub> is the input voltage to the LM2793, P<sub>IN</sub> is the power generated by the 1.5x charge pump, and P<sub>LED</sub> is the power consumed by the LEDs.

$$\begin{aligned} P_{DISSIPATION} &= P_{IN} - P_{LED} \\ &= (1.5V_{IN} - V_{DX}) \times I_{LOAD} \\ &= ((1.5 \times 5.5V) - 3.6V) \times 0.032A \\ &= 149mW \end{aligned}$$

## Application Information (Continued)

$$\begin{aligned}T_J &= T_A + (P_{DMAX} \times \theta_{JA}) \\&= 85^{\circ}\text{C} + (0.149\text{W} \times 55^{\circ}\text{C/W}) \\&= 93^{\circ}\text{C}\end{aligned}$$

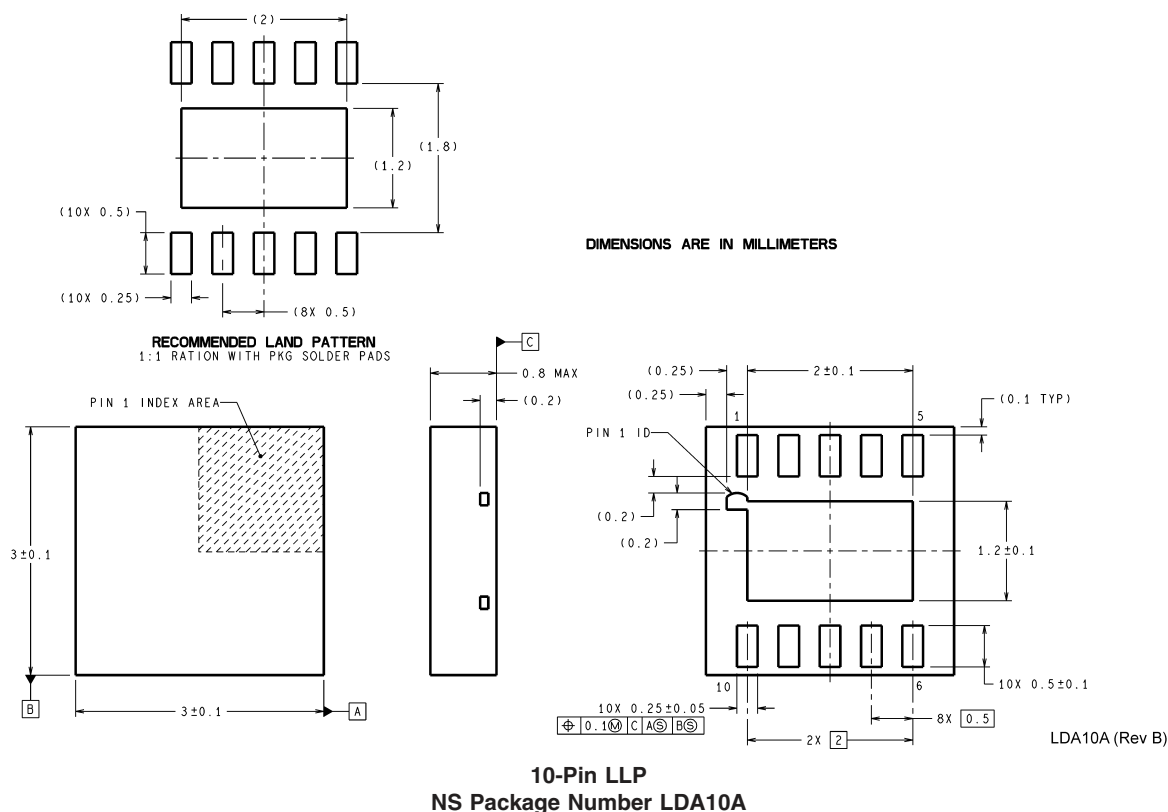
The junction temperature rating takes precedence over the ambient temperature rating. The LM2793 may be operated outside the ambient temperature rating, so long as the junction temperature of the device does not exceed the maximum operating rating of 100°C. The maximum ambient temperature rating must be derated in applications where high power dissipation and/or poor thermal resistance causes the junction temperature to exceed 100°C.

## PCB Layout Considerations

The LLP is a leadframe based Chip Scale Package (CSP) with very good thermal properties. This package has an exposed DAP (die attach pad) at the center of the package

measuring 2.0mm x 1.2mm. The main advantage of this exposed DAP is to offer lower thermal resistance when it is soldered to the thermal land on the PCB. For PCB layout, National highly recommends a 1:1 ratio between the package and the PCB thermal land. To further enhance thermal conductivity, the PCB thermal land may include vias to a ground plane. For more detailed instructions on mounting LLP packages, please refer to National Semiconductor Application Note AN-1187.

## Physical Dimensions inches (millimeters) unless otherwise noted



### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



**National Semiconductor**  
**Americas Customer**  
**Support Center**  
Email: new.feedback@nsc.com  
Tel: 1-800-272-9959

www.national.com

**National Semiconductor**  
**Europe Customer Support Center**  
Fax: +49 (0) 180-530 85 86  
Email: europe.support@nsc.com  
Deutsch Tel: +49 (0) 69 9508 6208  
English Tel: +44 (0) 870 24 0 2171  
Français Tel: +33 (0) 1 41 91 8790

**National Semiconductor**  
**Asia Pacific Customer**  
**Support Center**  
Fax: +65-6250 4466  
Email: ap.support@nsc.com  
Tel: +65-6254 4466

**National Semiconductor**  
**Japan Customer Support Center**  
Fax: 81-3-5639-7507  
Email: jpn.feedback@nsc.com  
Tel: 81-3-5639-7560

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
OMAP Mobile Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>

### Applications

Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
Transportation and Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>

TI E2E Community Home Page

[e2e.ti.com](http://e2e.ti.com)

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2011, Texas Instruments Incorporated